

# SLD750U / SLF750U

## 430V N-Channel MOSFET

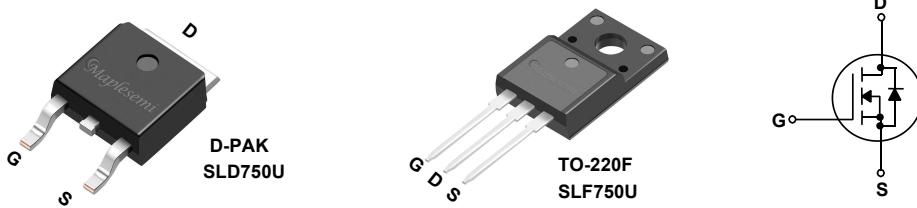
SLD750U / SLF750U

### General Description

This Power MOSFET is produced using Maple semi's advanced planar stripe DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency switched mode power supplies, active power factor correction based on half bridge topology.

### Features

- N-Channel: 430V 11A  
 $R_{DS(on)Typ} = 0.54\Omega @ V_{GS} = 10\text{ V}$
- Very Low On-resistance RDS(ON)
- Low Crss
- Fast switching
- 100% avalanche tested
- Improved dv/dt capability



### Absolute Maximum Ratings

$T_c = 25^\circ\text{C}$  unless otherwise noted

Symbol	Parameter	SLD750U / SLF750U		Units	
$V_{DSS}$	Drain-Source Voltage	430		V	
$I_D$	Drain Current - Continuous ( $T_c = 25^\circ\text{C}$ )	11	A		
	- Continuous ( $T_c = 100^\circ\text{C}$ )				
$I_{DM}$	Drain Current - Pulsed (Note 1)	33		A	
$V_{GSS}$	Gate-Source Voltage	$\pm 30$		V	
$E_{AS}$	Single Pulsed Avalanche Energy	437		mJ	
$P_D$	Power Dissipation ( $T_c = 25^\circ\text{C}$ )	-	35	W	
$R_{\theta JC}$	Thermal Resistance, Junction to Case	-	3.57	$\text{W}/^\circ\text{C}$	
$T_J, T_{STG}$	Operating and Storage Temperature Range	-55 to +150		$^\circ\text{C}$	
$T_L$	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds	300		$^\circ\text{C}$	

\* Drain current limited by maximum junction temperature.

## Package Marking

Part Number	Top Marking	Package	Packing Method	MOQ	QTY
SLD750U	SLP750U	TO-252	Tape	2500	25000
SLF750U	SLF750U	TO-220F	Tube	1000	5000

## Electrical Characteristics

$T_c = 25^\circ\text{C}$  unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
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### Off Characteristics

BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	430	--	--	V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = 400 \text{ V}, V_{GS} = 0 \text{ V}$	--	--	1	uA
		$V_{DS} = 340 \text{ V}, T_c = 125^\circ\text{C}$	--	--	10	uA
I <sub>GSSF</sub>	Gate-Body Leakage Current, Forward	$V_{GS} = 30 \text{ V}, V_{DS} = 0 \text{ V}$	--	--	100	nA
I <sub>GSSR</sub>	Gate-Body Leakage Current, Reverse	$V_{GS} = -30 \text{ V}, V_{DS} = 0 \text{ V}$	--	--	-100	nA

### On Characteristics

V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250 \mu\text{A}$	2	-	4	V
R <sub>D(on)</sub>	Static Drain-Source On-Resistance	$V_{GS} = 10 \text{ V}, I_D = 5.5 \text{ A}$	--	0.54	0.62	$\Omega$

### Dynamic Characteristics

C <sub>iss</sub>	Input Capacitance	$V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V}, f = 1.0 \text{ MHz}$	--	835	-	pF
C <sub>oss</sub>	Output Capacitance		--	98	-	pF
C <sub>rss</sub>	Reverse Transfer Capacitance		--	3.85	-	pF

### Switching Characteristics

t <sub>d(on)</sub>	Turn-On Delay Time	$V_{DS} = 210 \text{ V}, R_G = 25 \Omega, I_D = 5.5 \text{ A}$	--	19	--	ns
t <sub>r</sub>	Turn-On Rise Time		--	70	--	ns
t <sub>d(off)</sub>	Turn-Off Delay Time		--	70	--	ns
t <sub>f</sub>	Turn-Off Fall Time		--	27	--	ns
Q <sub>g</sub>	Total Gate Charge	$V_{DS} = 210 \text{ V}, I_D = 5.5 \text{ A}, V_{GS} = 10 \text{ V}$	--	23	--	nC
	Gate-Source Charge		--	5.4	--	nC
	Gate-Drain Charge		--	5	--	nC

### Drain-Source Diode Characteristics and Maximum Ratings

I <sub>s</sub>	Maximum Continuous Drain-Source Diode Forward Current	--	--	11	A
I <sub>SM</sub>	Maximum Pulsed Drain-Source Diode Forward Current	--	--	33	A
V <sub>SD</sub>	Drain to Source Diode Forward Voltage, $V_{GS} = 0 \text{ V}, I_{SD} = 11 \text{ A}, T_J = 25^\circ\text{C}$	--	--	1.4	V
t <sub>rr</sub>	Reverse Recovery Time & $T_J = 25^\circ\text{C}$ , IF = 5.5A di/dt = 100A/ $\mu\text{s}$	--	410	-	nS
Q <sub>rr</sub>	Reverse Recovery Charge & $T_J = 25^\circ\text{C}$ , IF = 5.5A di/dt = 100A/ $\mu\text{s}$	--	7	-	nC

#### Notes:

1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature
2. EAS condition:  $T_J = 25^\circ\text{C}$ ,  $V_{DD} = 50 \text{ V}$ ,  $V_G = 10 \text{ V}$ ,  $R_G = 25 \Omega$ ,
3. Pulse Test: Pulse Width  $\leq 300 \mu\text{s}$ , Duty Cycle  $\leq 0.5\%$

## N-Channel Typical Characteristics

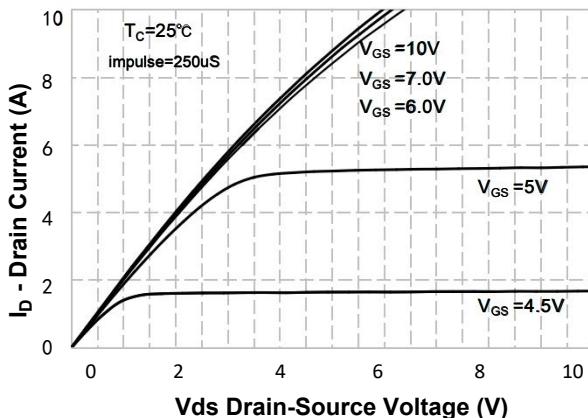


Figure 1. On-Region Characteristics

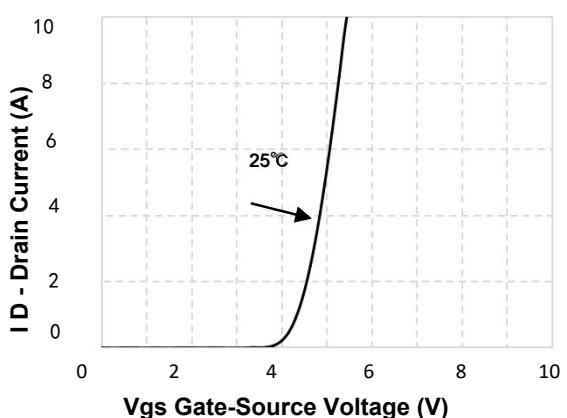


Figure 2. Transfer Characteristics

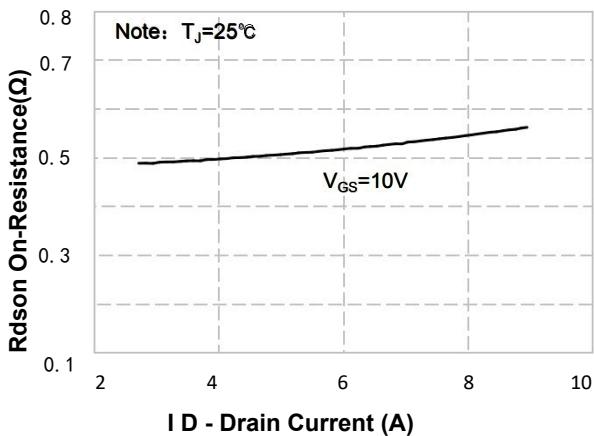


Figure 3. On-Resistance Variation vs Drain Current and Gate Voltage

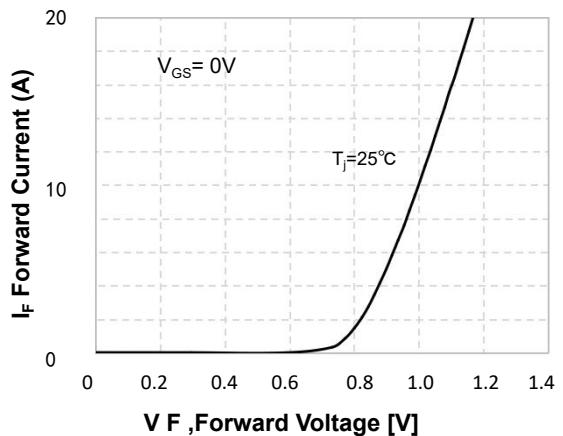


Figure 4. Body Diode Forward Voltage Variation with Source Current and Temperature

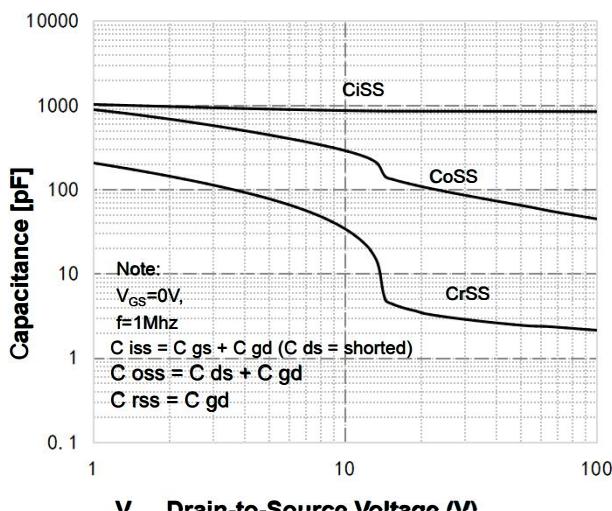


Figure 5. Capacitance Characteristics

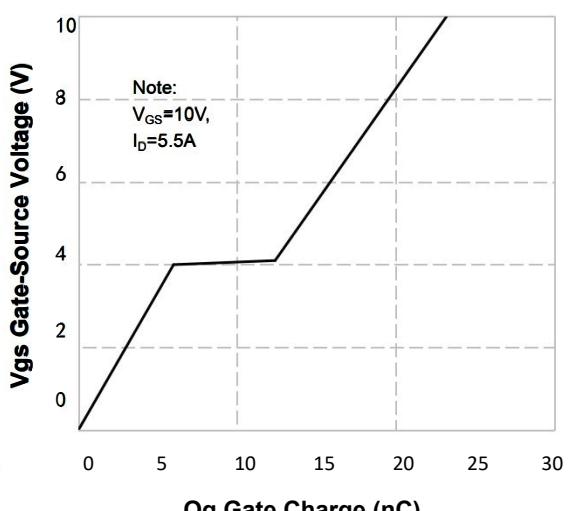
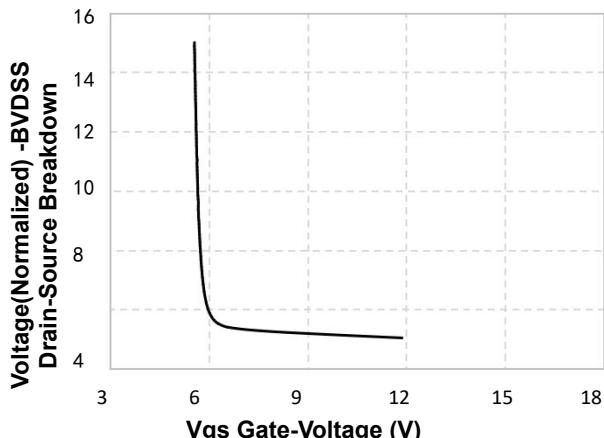
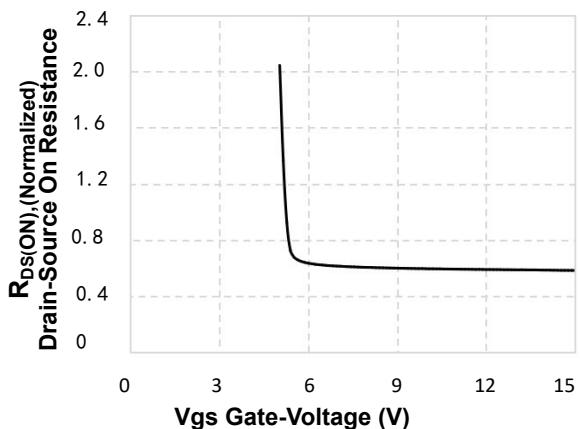


Figure 6. Gate Charge Characteristics

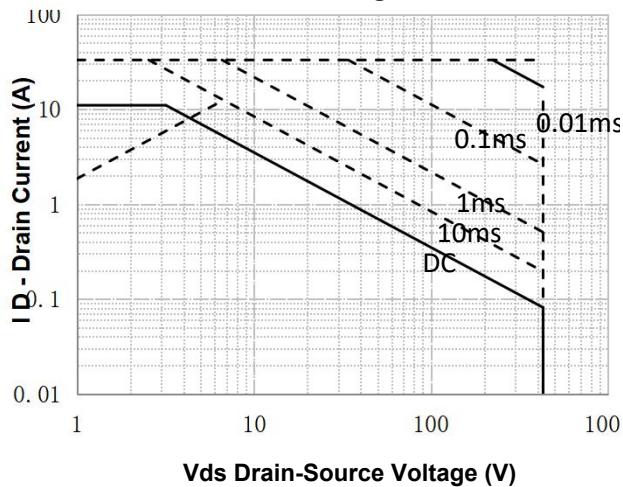
## Typical Characteristics (Continued)



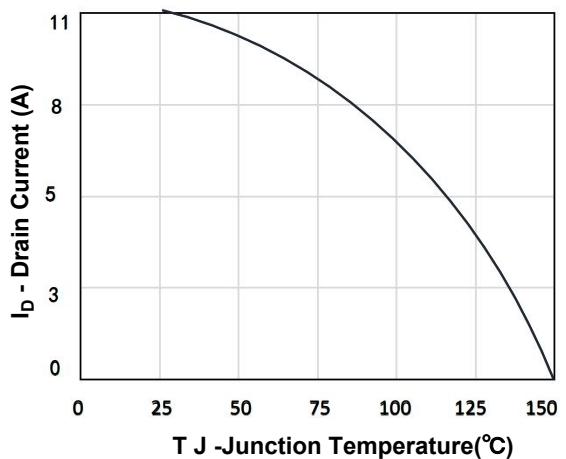
**Figure 7. Breakdown Voltage Variation vs Gate-Voltage**



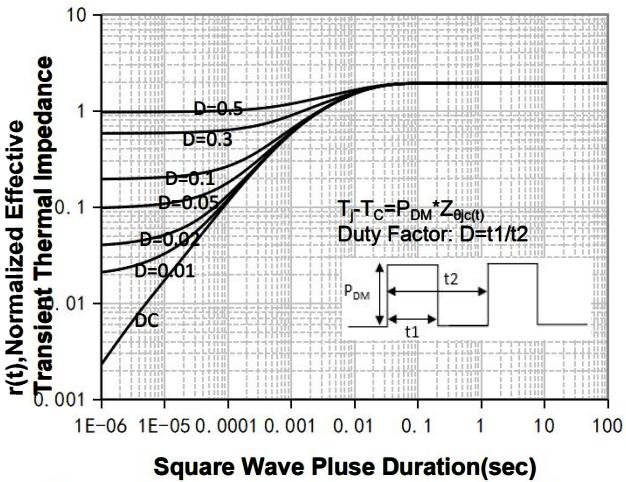
**Figure 8. On-Resistance Variation vs Gate-Voltage**



**Figure 9. Maximum Safe Operating Area**

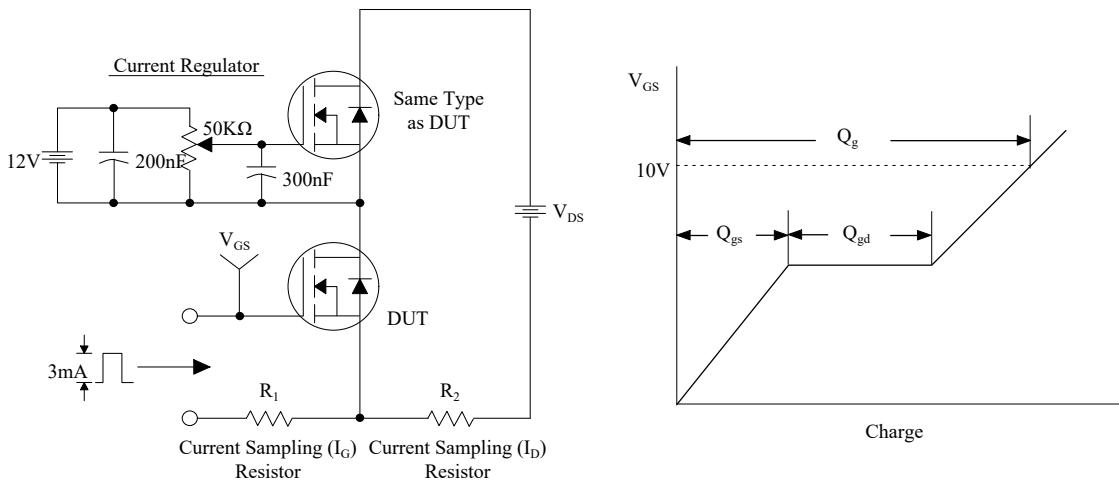


**Figure 10. Maximum Drain Current vs Case Temperature**

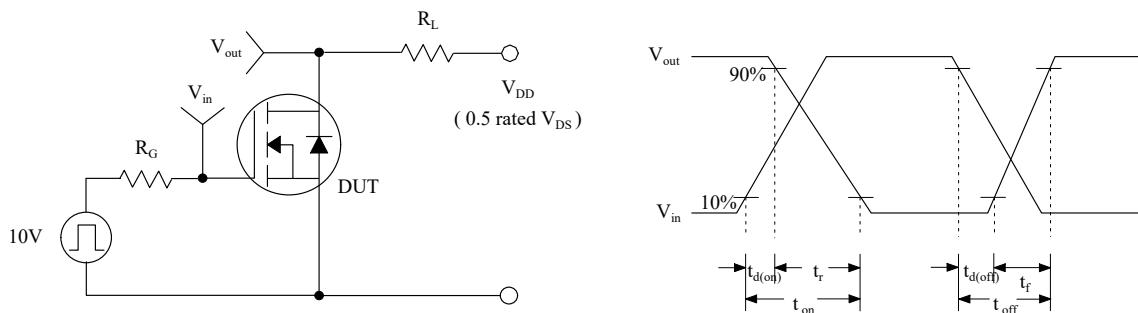


**Figure 11. Transient Thermal Response Curve**

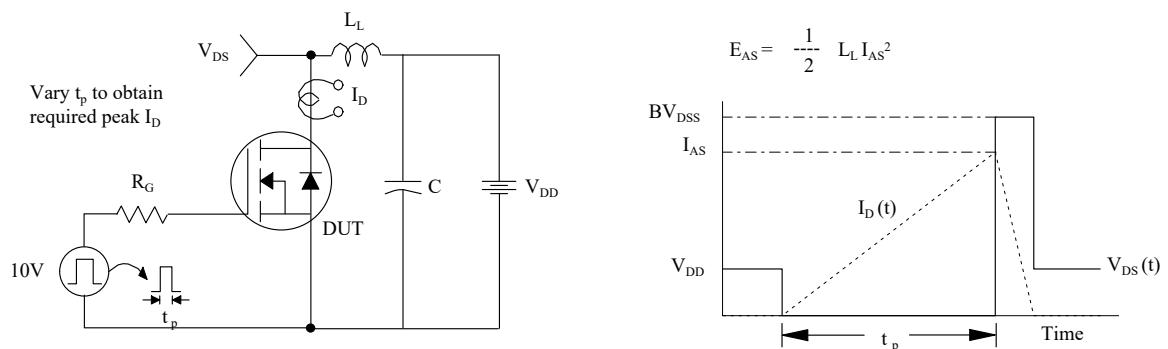
## Gate Charge Test Circuit & Waveform



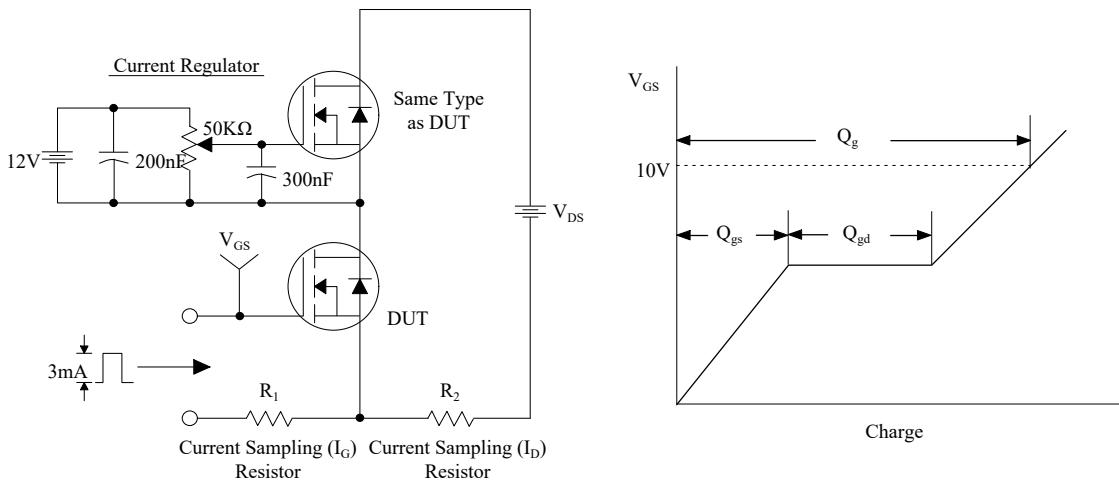
## Resistive Switching Test Circuit & Waveforms



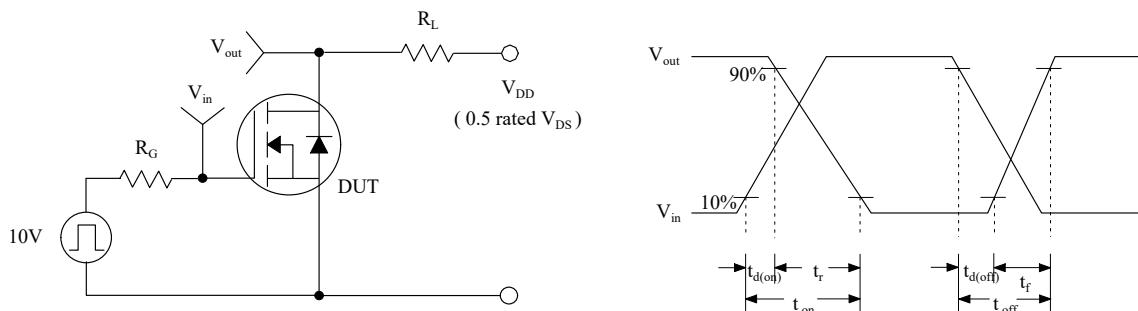
## Unclamped Inductive Switching Test Circuit & Waveforms



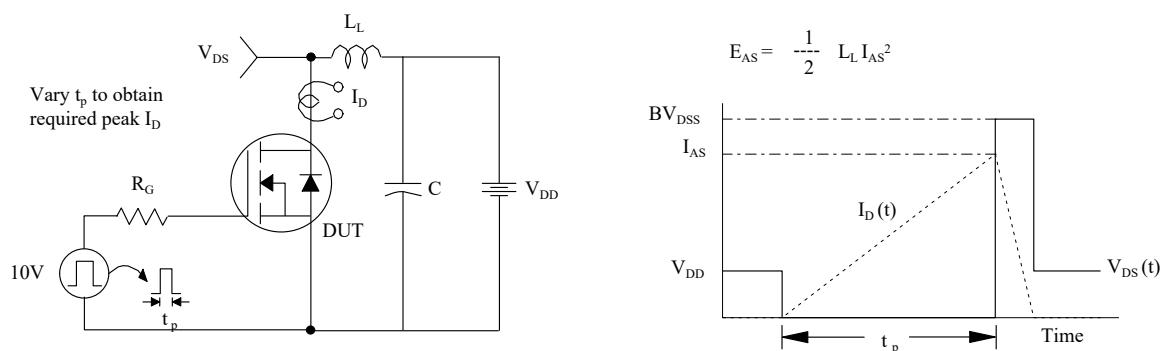
## Gate Charge Test Circuit & Waveform



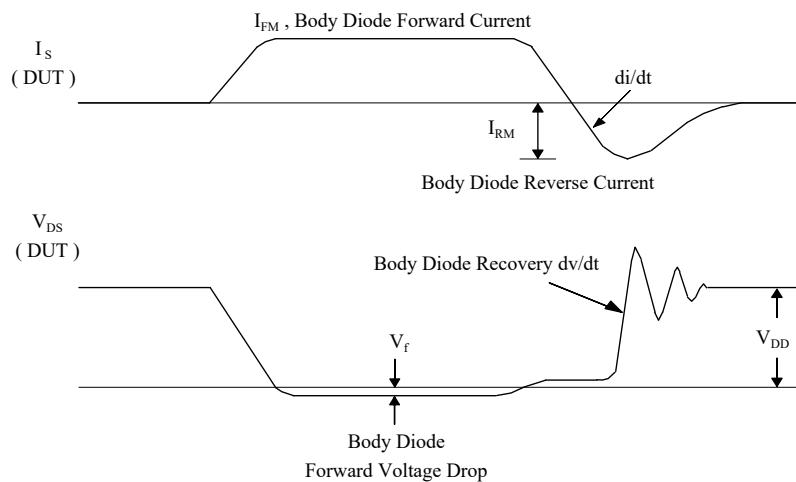
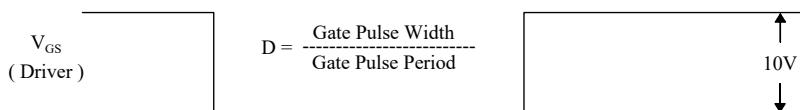
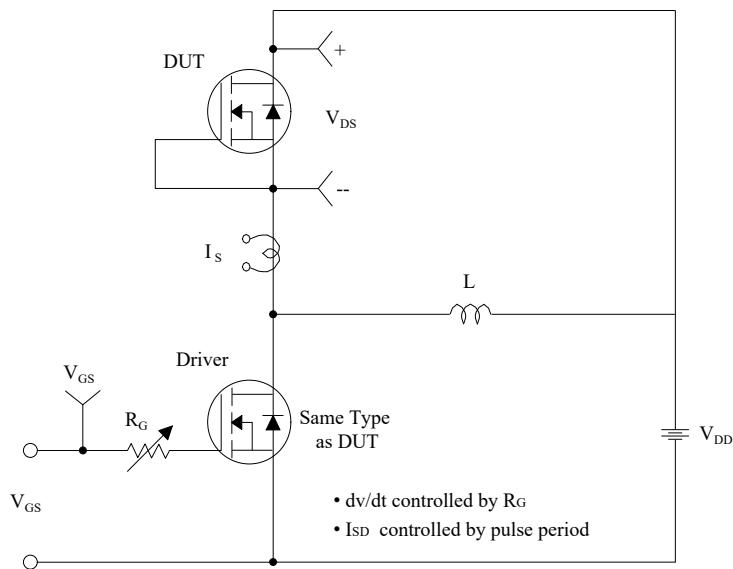
## Resistive Switching Test Circuit & Waveforms

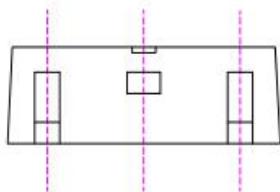
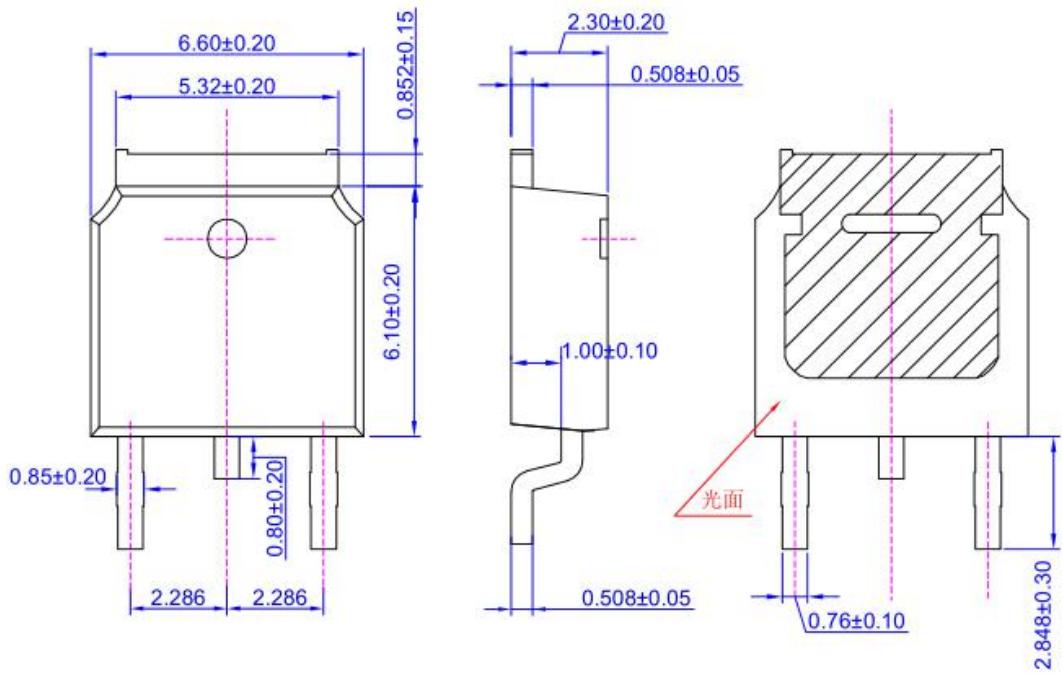


## Unclamped Inductive Switching Test Circuit & Waveforms



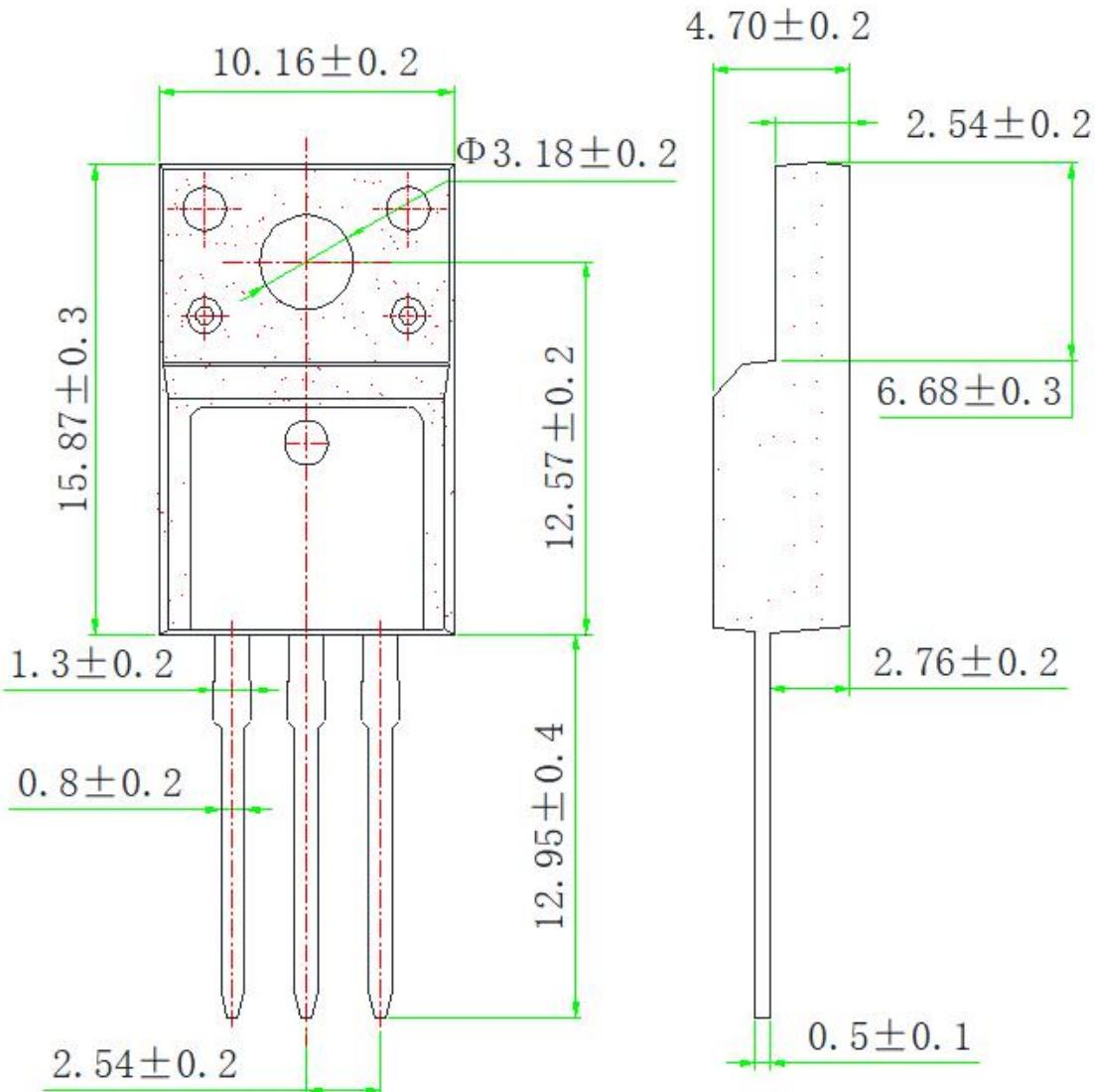
## Peak Diode Recovery dv/dt Test Circuit & Waveforms



**TO-252 OUTLINE****NOTE:**

- 1.The plastic package is not marked as smooth surfaceRa=0.1;Subglossy surfaceRa=0.8
- 2.Undeclared tolerance  $\pm 0.25$ ,Unmarked filletRmax=0.25

# TO-220F OUTLINE



**Note:** Distance from top pinhole to colloid surface  $0.8 \pm 0.15$ mm

NAME	TO-220F OUTLINE	UNIT	mm	DESIGNED	Shawn Chen	THIRD ANGLE SYSTEM
DWGNO		PAGE	1 OF 1	CHECKED		
VERSION	Ver1.0	ISSUE DATE		APPROVED		

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